

## Product Summary

| $V_{(BR)DSS}$ | $R_{DS(on)TYP}$ | $I_D$ |
|---------------|-----------------|-------|
| -20V          | 400mΩ@-4.5V     | -0.7A |
|               | 550mΩ@-2.5V     |       |



**合肥矽普半导体**

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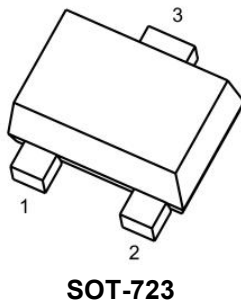
## Feature

- High power and current handling capability
- Surface mount package
- ESD protected 2KV

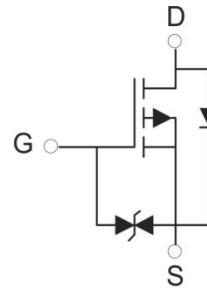
## Application

- Battery Switch
- DC/DC Converter

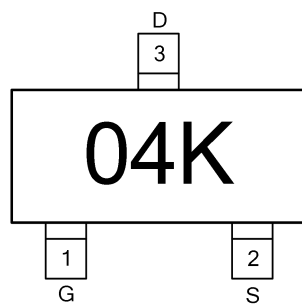
## Package



## Circuit diagram



## Marking



**04K** :Device Code

## Order Information

| Device    | Package | Unit/Tape |
|-----------|---------|-----------|
| SP2004KT7 | SOT-723 | 8000      |

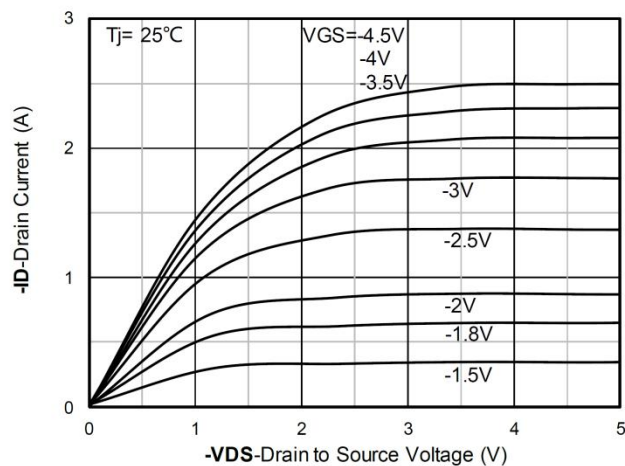
**Absolute maximum ratings (Ta=25°C, unless otherwise noted)**

| Parameter                              | Symbol          | Value      | Unit |
|----------------------------------------|-----------------|------------|------|
| Drain-Source Voltage                   | $V_{DS}$        | -20        | V    |
| Gate-Source Voltage                    | $V_{GS}$        | $\pm 12$   | V    |
| Continuous Drain Current               | $I_D$           | -0.7       | A    |
| Pulse Drain Current Tested             | $I_{DM}$        | -2.8       | A    |
| Power Dissipation                      | $P_D$           | 150        | mW   |
| Thermal Resistance Junction-to-Ambient | $R_{\theta JA}$ | 833        | °C/W |
| Storage Temperature Range              | $T_{STG}$       | -55 to 150 | °C   |
| Operating Junction Temperature Range   | $T_J$           | -55 to 150 | °C   |

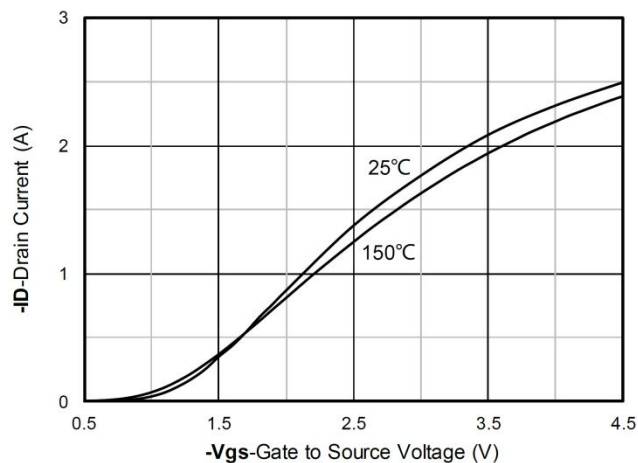
**Electrical characteristics (Ta=25°C, unless otherwise noted)**

| Parameter                          | Symbol            | Conditions                              | Min.  | Typ.  | Max.  | Unit |
|------------------------------------|-------------------|-----------------------------------------|-------|-------|-------|------|
| Static Characteristics             |                   |                                         |       |       |       |      |
| Drain-Source Breakdown Voltage     | BV <sub>DSS</sub> | VGS=0V , ID=-250μA                      | -20   | -     | -     | V    |
| Drain-Source Leakage Current       | IDSS              | VDS=-16V , VGS=0V                       | -     | -     | -1    | uA   |
| Gate-Source Leakage Current        | IGSS              | VGS=±12V , VDS=0V                       | -     | -     | ±10   | uA   |
| Gate Threshold Voltage             | VGS(th)           | VDS=VGS , ID=-250μA                     | -0.35 | -0.65 | -1.00 | V    |
| Static Drain-Source On-Resistance  | RDS(on)           | VGS=-4.5V , ID=-500mA                   | -     | 400   | 550   | mΩ   |
|                                    |                   | VGS=-2.5V , ID=-200mA                   | -     | 550   | 700   |      |
| Dynamic characteristics            |                   |                                         |       |       |       |      |
| Input Capacitance                  | Ciss              | VDS=-16V , VGS=0V , f=1MHz              | -     | 113   | -     | pF   |
| Output Capacitance                 | Coss              |                                         | -     | 15    | -     |      |
| Reverse Transfer Capacitance       | Crss              |                                         | -     | 9     | -     |      |
| Total Gate Charge                  | Qg                | VDS=-10V , VGS=-4.5V , ID=-2A           | -     | 1.9   | -     | nC   |
| Gate-Source Charge                 | Qgs               |                                         | -     | 0.4   | -     |      |
| Gate-Drain Charge                  | Qgd               |                                         | -     | 0.31  | -     |      |
| Switching Characteristics          |                   |                                         |       |       |       |      |
| Turn-On Delay Time                 | td(on)            | VDD=-10V VGS=-4.5V , RG=10Ω , ID=-200mA | -     | 9     | -     | nS   |
| Turn-On Rise Time                  | tr                |                                         | -     | 5.7   | -     |      |
| Turn-Off Delay Time                | td(off)           |                                         | -     | 32.6  | -     |      |
| Turn-Off Fall Time                 | tr                |                                         | -     | 20.3  | -     |      |
| Source-Drain Diode characteristics |                   |                                         |       |       |       |      |
| Diode Forward Voltage              | VSD               | VGS=0V , IS=-1A , TJ=25℃                | -     | -     | -1.2  | V    |

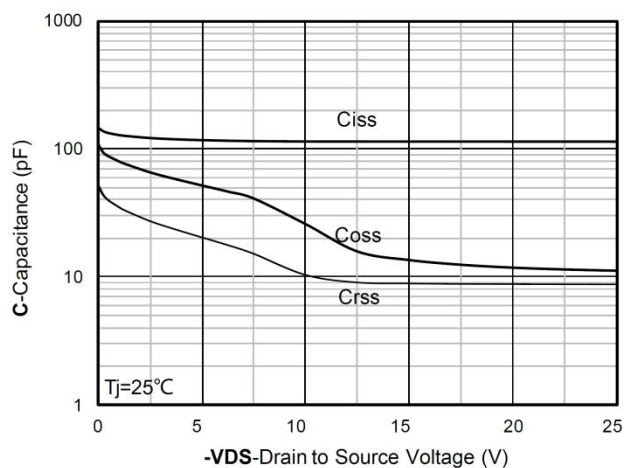
## Typical Characteristics



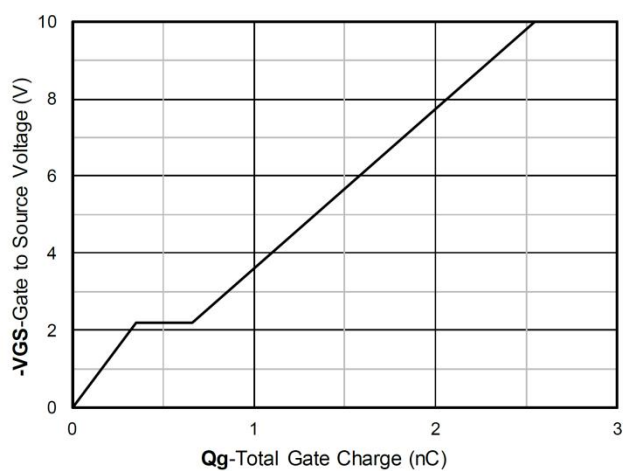
Output Characteristics



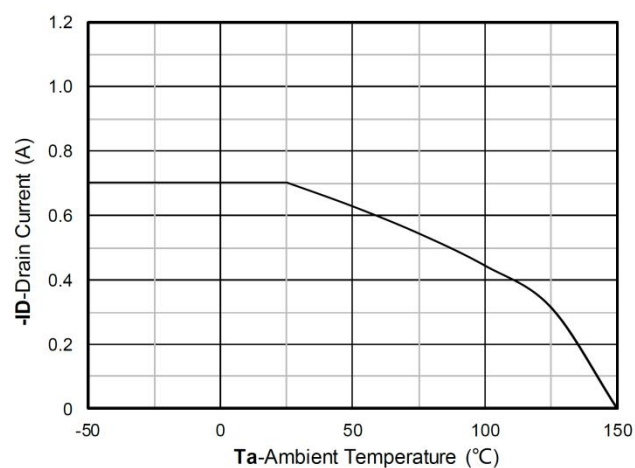
Transfer Characteristics



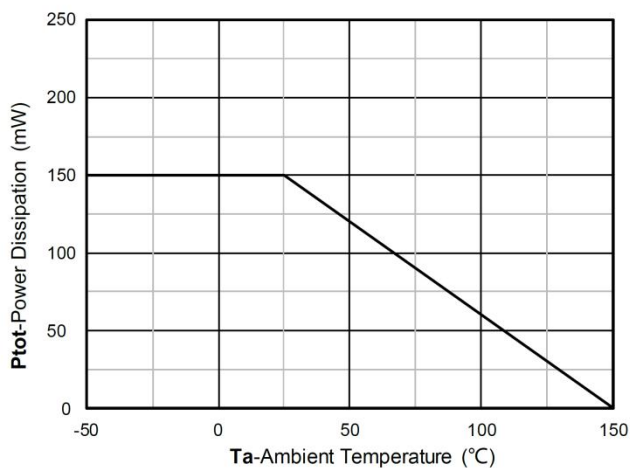
Capacitance Characteristics



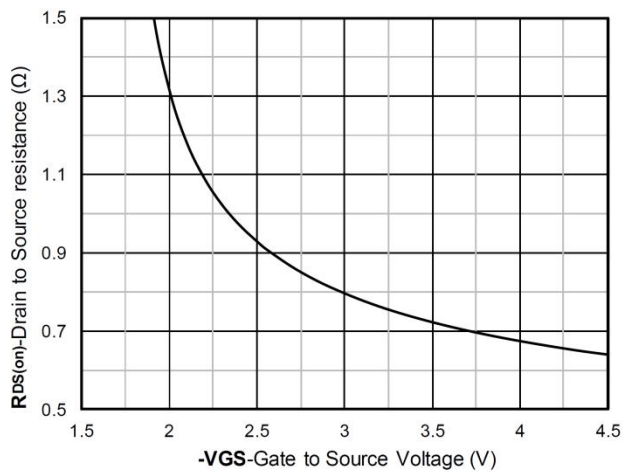
Gate Charge



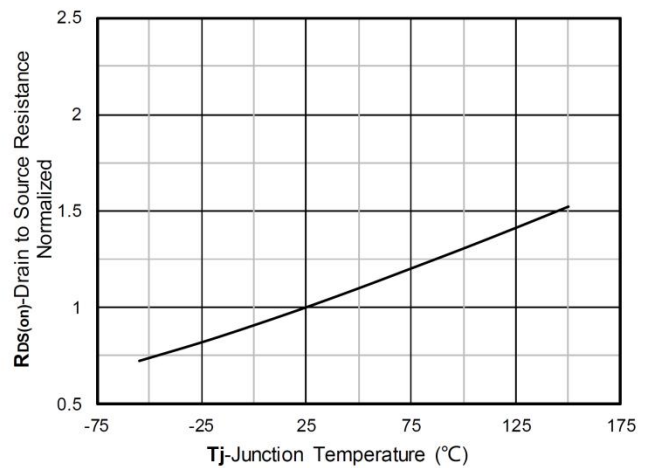
Current dissipation



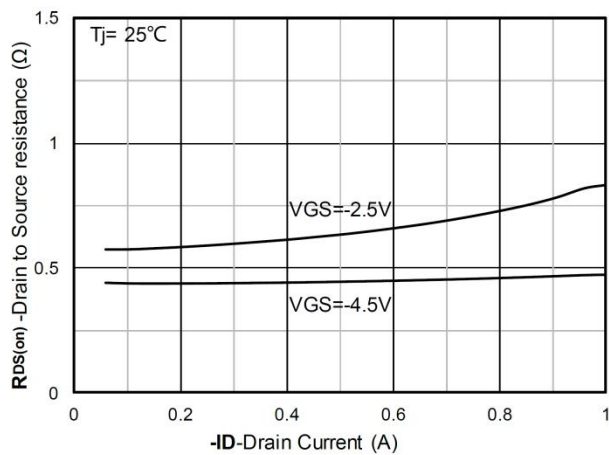
Power dissipation



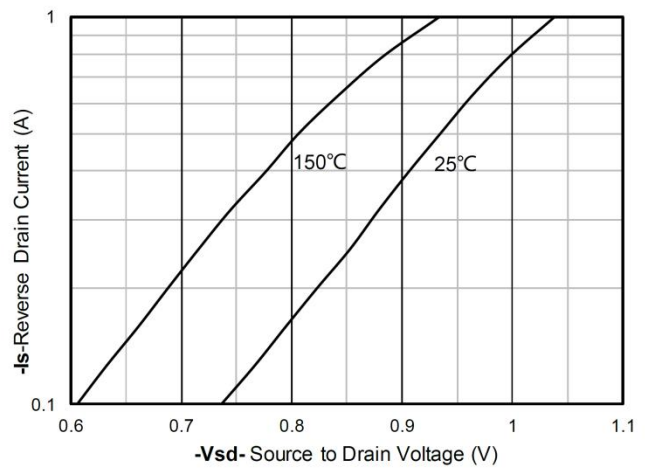
On-Resistance vs Gate to Source Voltage



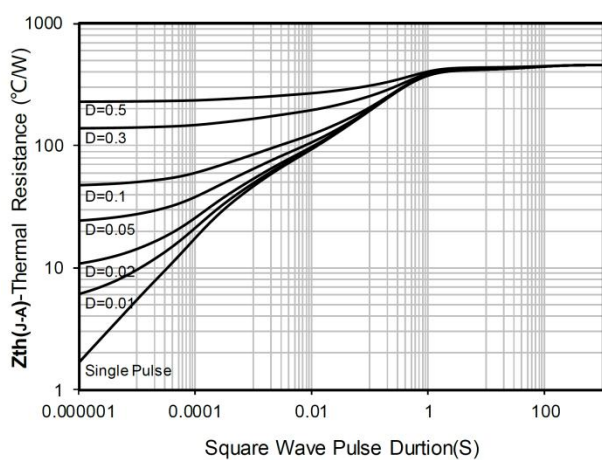
Normalized On-Resistance



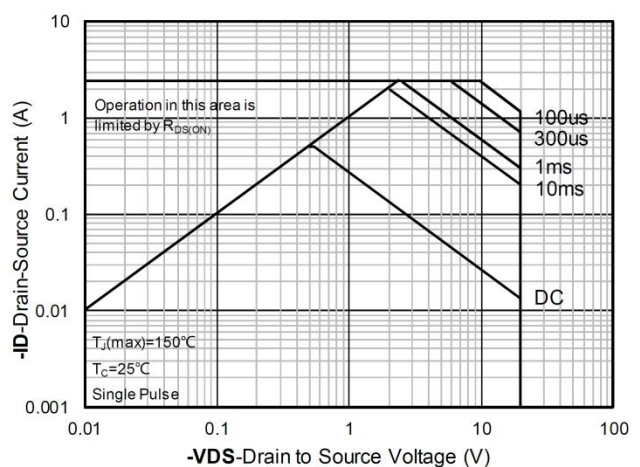
RDS(on) VS Drain Current



Forward characteristics of reverse diode

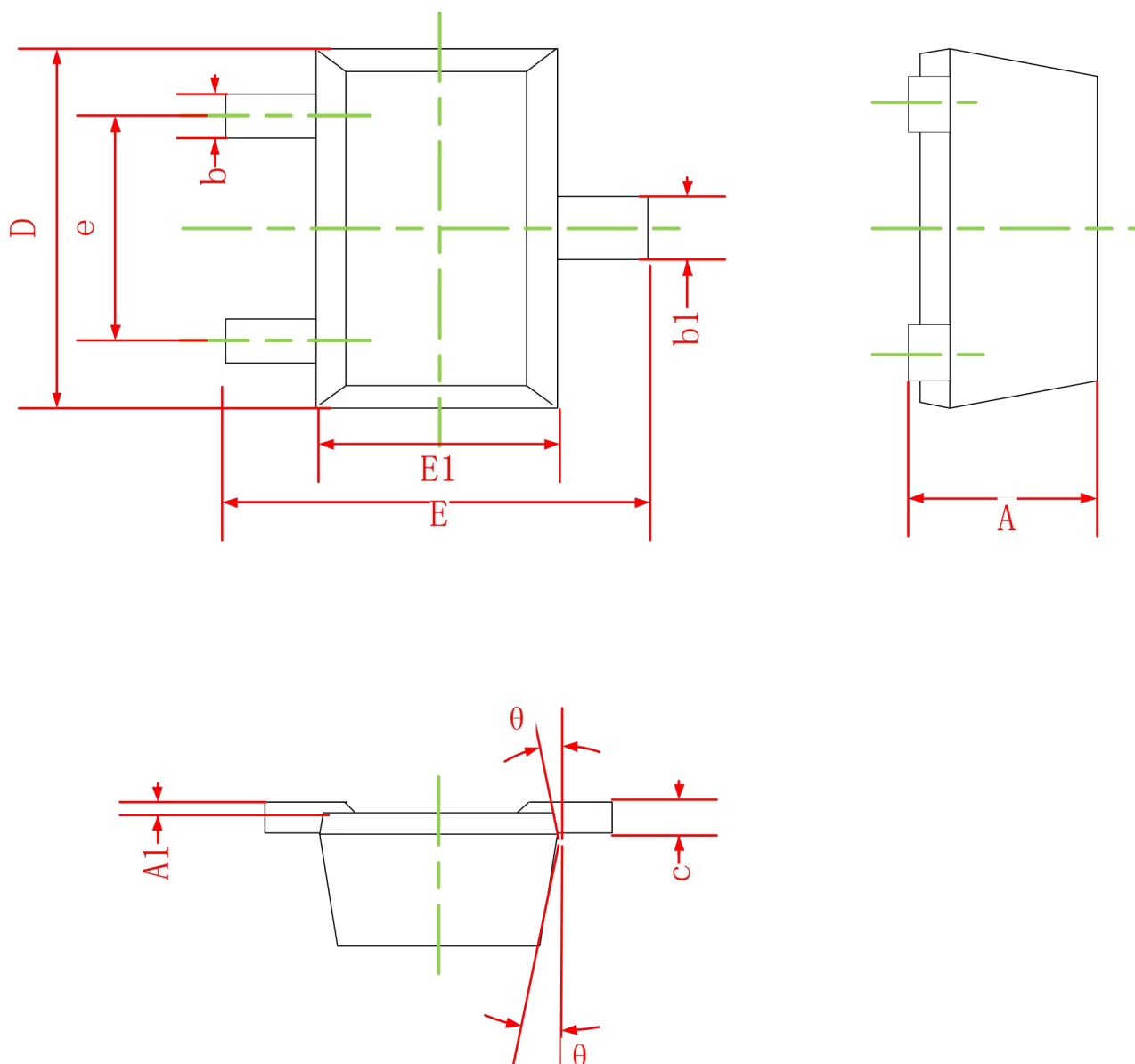


Maximum Transient Thermal Impedance



Safe Operation Area

## SOT-723 Package Information



| Symbol   | Dimensions In Millimeters |       |
|----------|---------------------------|-------|
|          | Min.                      | Max.  |
| A        | 0.430                     | 0.500 |
| A1       | 0.000                     | 0.050 |
| b        | 0.170                     | 0.270 |
| b1       | 0.270                     | 0.370 |
| c        | 0.080                     | 0.150 |
| D        | 1.150                     | 1.250 |
| E        | 1.150                     | 1.250 |
| E1       | 0.750                     | 0.850 |
| e        | 0.800TYP.                 |       |
| $\theta$ | 7° REF.                   |       |